

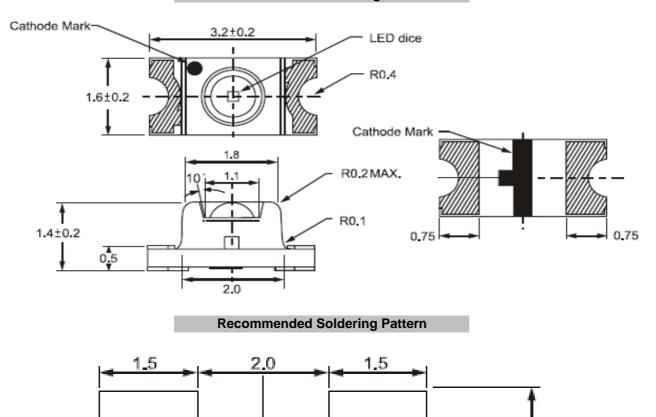


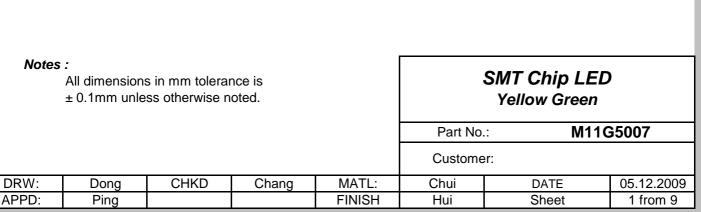
#### Applications

Interior automotive lighting

 Optical indicators
 Communication Products
 Backlighting
 Toys

#### **Technical Drawing**





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#### Absolute Maximum Ratings

Ta=25°C

Item	Symbol	GaP	Unit
Power Dissipation	PD		mW
DC Forward Current	I <sub>F</sub>	30	mA
Plused Forward Current	I <sub>FP</sub> *	100	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	T <sub>OP</sub>	-25 to 80	°C
Storage Temperature	T <sub>ST</sub>	-40 to 85	°C

\* 0.1 msec pulse, 10% duty cycle

#### Electrcal / Optical Characteristics

I<sub>F</sub>=20mA Ta=25°C

Ermitting Color		Yellow Green					
Material		GaP					
Forward Voltage	typ.	2.0	V <sub>F</sub>				
r orward voltage	max.	2.6	V <sub>F</sub>				
Wavelength	λD	570	nm				
-	λP	570	nm				
typ.	Δλ		nm				
Color Temperature	min.		K				
	max.		K				
Luminous Intensity *	min.	42	mcd				
Lumnous mensity	typ.	75	mcd				
Reverse Current	max.		μA				
Viewing Angle	201/2	60					

\* Per NIST standards

SM	T	Chip	LED
		-	

Yellow Green

		Part No.	.: M110	G5007						
Customer:										
DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	05.12.2009			
APPD:	Ping			FINISH	Hui	Sheet	2 from 9			
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**Directive Characteristics** 

# SMT Chip LED

Yellow Green

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# SMT Chip LED

Yellow Green

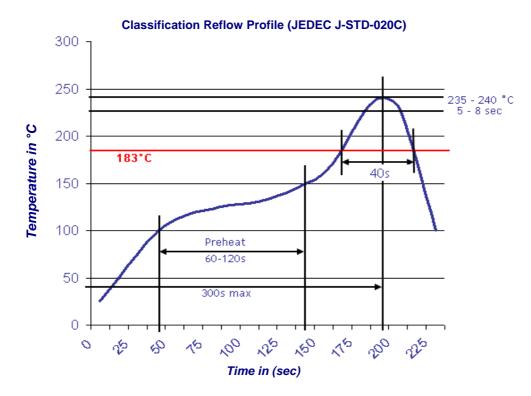
					Part No.: <b>M11G5007</b>					
Customer:										
DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	05.12.2009			
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#### **Solder Condition**

#### Lead Free Solder

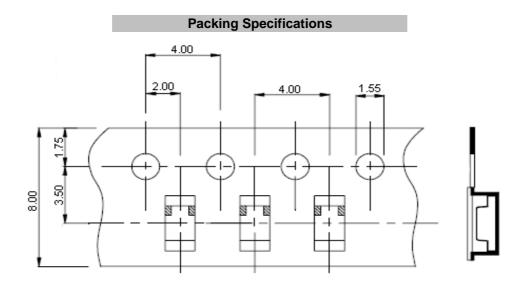


### SMT Chip LED Yellow Green

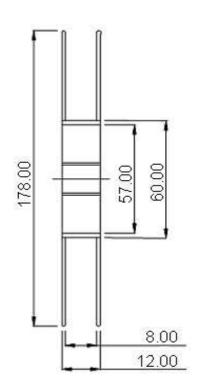
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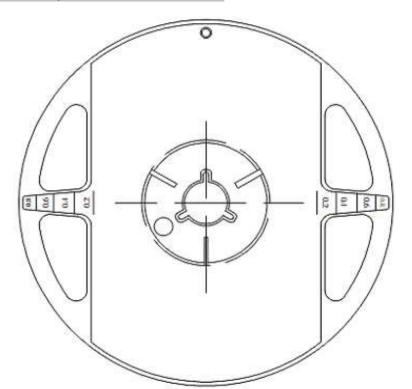






**Reel Specifications** 





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Part No.: <b>M11G5007</b>							G5007	
Customer:								
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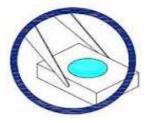




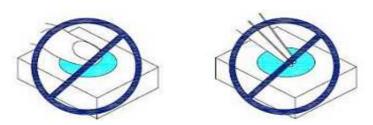
#### Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



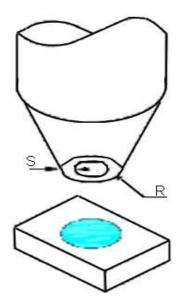
						SMT Chip LED Yellow Green	)
Part No.: <b>M11G5007</b>							
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- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



## SMT Chip LED

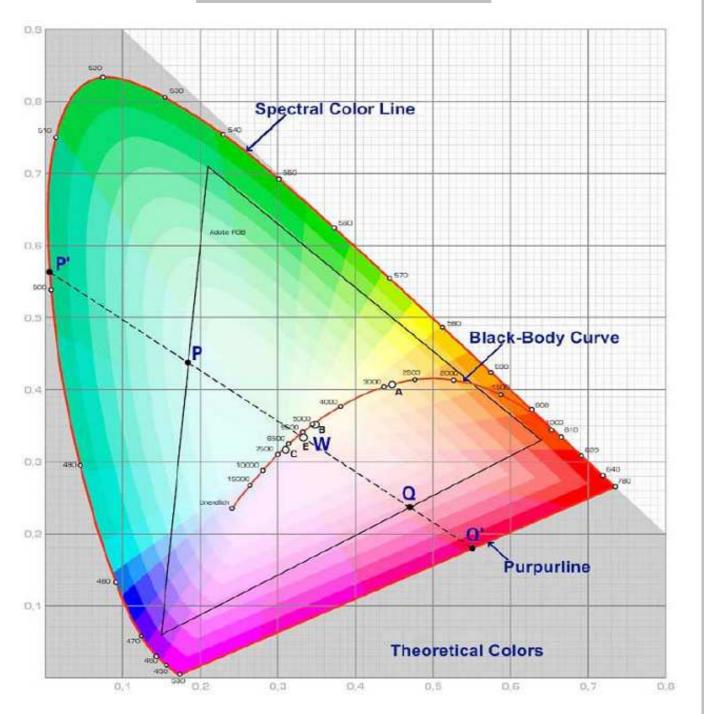
Yellow Green

			Part No.	.: M110	G5007					
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Color table curve



					SMT Chip LED Yellow Green			
					Part No.: <b>M11G5007</b>			
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